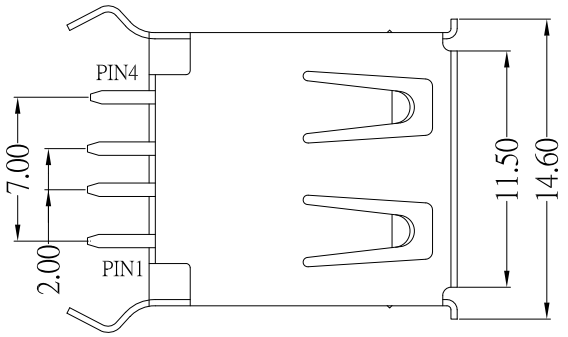
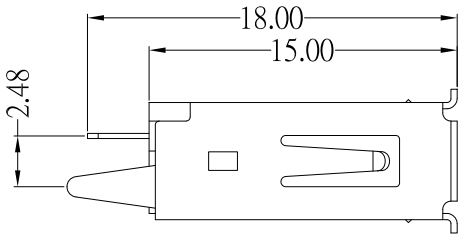
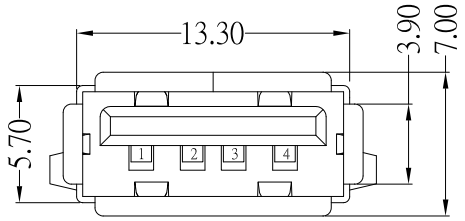


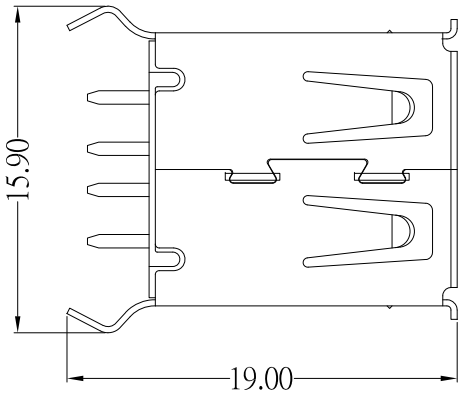
SUA-110V-x-x-S129

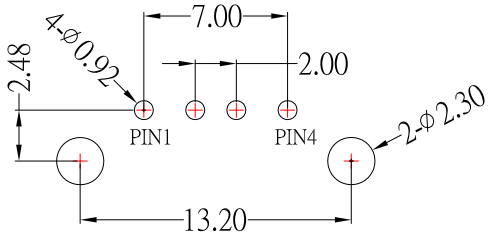
鍍層厚度：	COLOR :
Blank : 1u"	Black: B
2 : 15u"	White : W
3 : 30u"	

RoHS Compliant









P.C.B LAYOUT MOUNTING PATTERN

SPECIFICATIONS

1.MATERIAL:

a.HOUSING:PBT

b.CONTACT:BRASS

c.SHEEL: BRASS

2.PLATING :

a.CONTACT: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

b.PLATING: Nickel under Plated surface layer

3.ELECTRICAL:

a.DIELECTRIC WITHSTANDING VOLTAGE: AC 500V

b.INSULATION RESISTANCE: 1,000MΩ MIN

c.CONTACT RESISTANCE: 30 mΩ MAX;

3.MECHANICAL:

a.INSERTION FORCE: 3.57kg MAX

b.WITHDRAWAL FORCE: 1.02kg MIN

ITEM NO.	DESCRIPTION	DRAWN	DATE
4	更新尺寸	Jack	061919
3	新增PIN編號	Jack	062118
2	更新尺寸	Jack	050917
1	更新spec及材質	Jack	110813

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 06/19/19	MAT'L	
CHECKED BY: Jacky Chen	DATE 06/19/19	FINISH	
APPROVED BY: Tony Kao	DATE 06/19/19	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	USB AF VERTICAL TYPE DIP		
DWG NO.	SUA-110V-x-x-S129	SIZE	A4
PART NO.	SUA-110V-x-x-S129	VER	R4